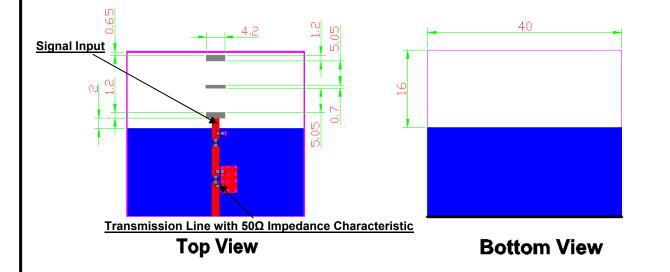


5. Layout Guide & Electrical Specifications

5-1. Layout Guide (unit : mm)

Solder Land Pattern:

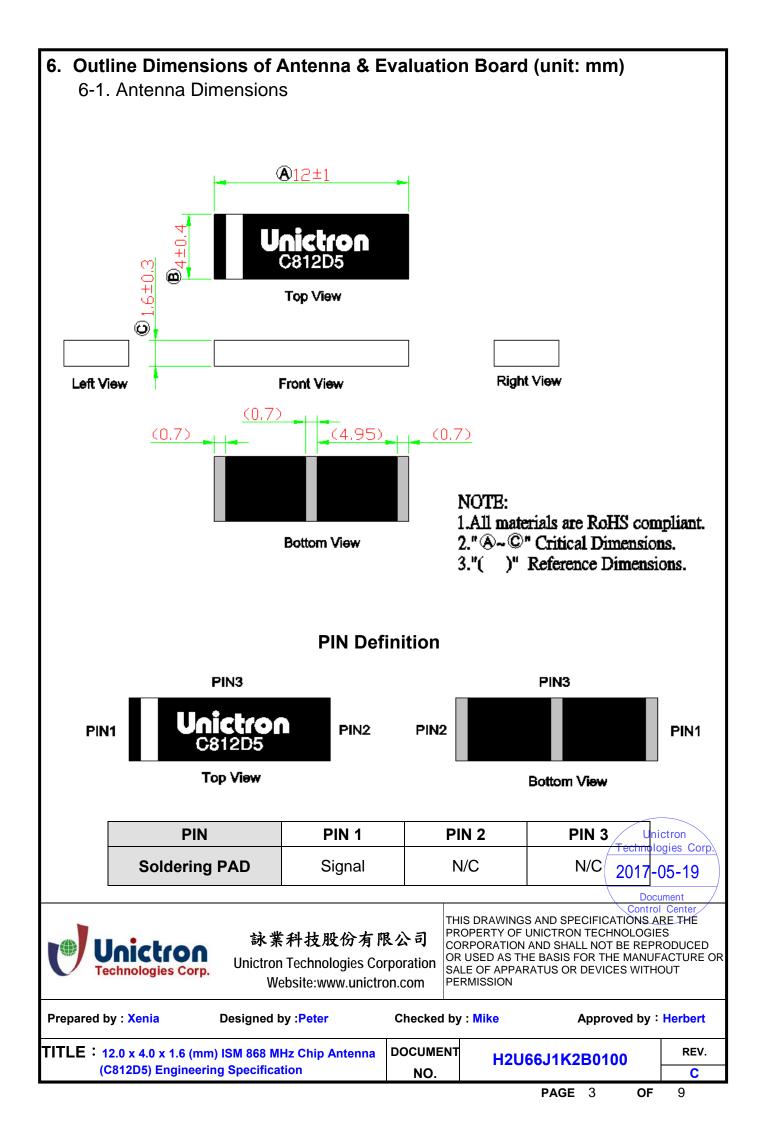
The solder land pattern (gray marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.

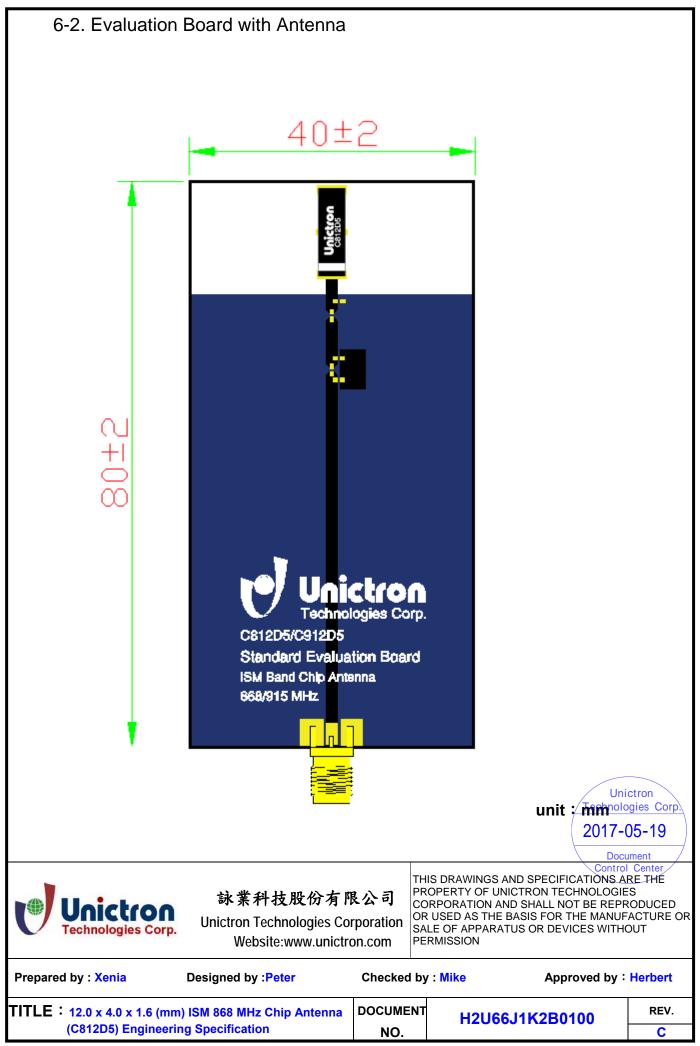


5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm²) 5-2-1. Electrical Table (863 ~ 870 MHz Band)

	Characteristics		S	pecifications	Uı	nit		
	Outline Dimensions		1	12.0 x 4.0 x 1.6		m		
	Ground Plane Dimensions		64 x 40		m	m		
	Norking Frequency			863 ~ 870		Hz		
	VSWR (@ center frequency)*		2 Max.					
	Characteristic Impedance Polarization		50		2	2		
Î			Lin	Linear Polarization				
	Peak Gain	(@ 868 MHz)	-	-0.6(typical)**		dBi		
	Efficiency		35.3(typical)**		T a alama fa	6 tron		
*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation tevaluation t								
ľ	Uniction Technologies Corp.			Control Center THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OF SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION		RE THÉ ES RODUCED FACTURE OR		
Pre	Prepared by : Xenia Designed by : Peter Checked by : Mike Approved by : Herbert							
FIT	ITLE : 12.0 x 4.0 x 1.6 (mm) ISM 868 MHz Chip Antenna (C812D5) Engineering Specification			UMENT H2U66J1K2B0100 NO.		REV.		
						С		

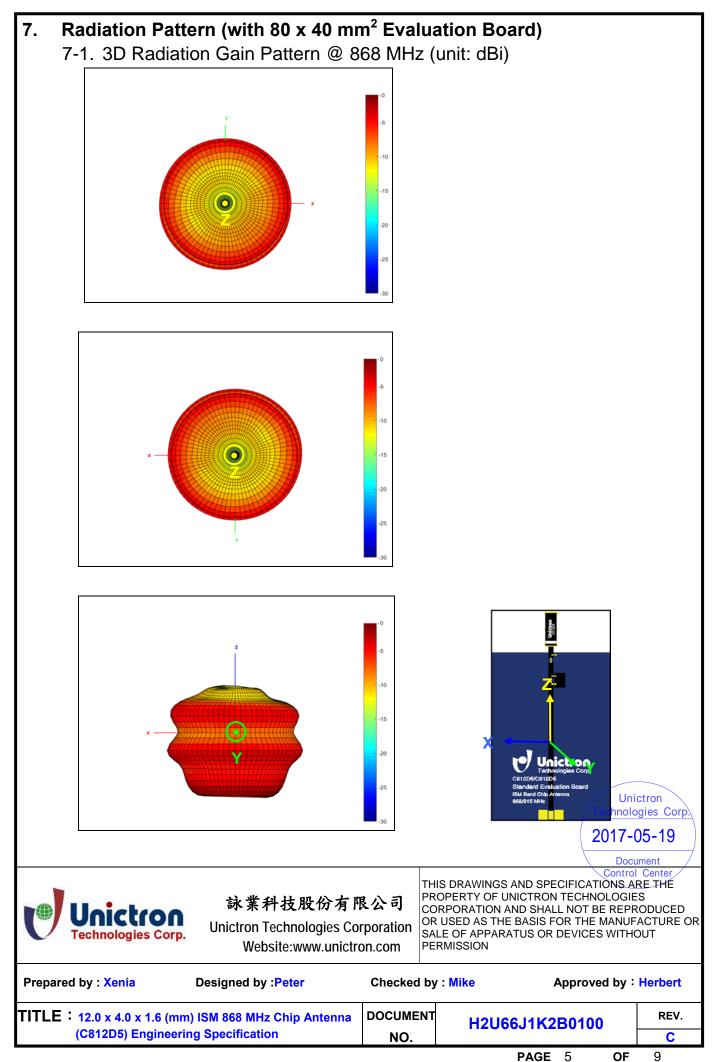
9

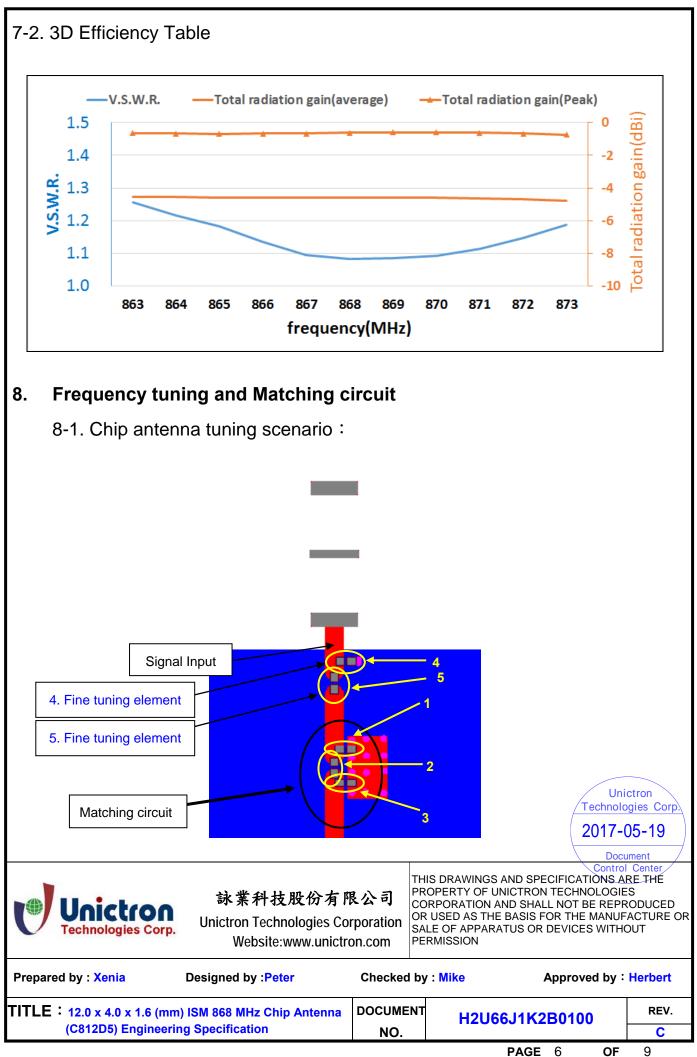




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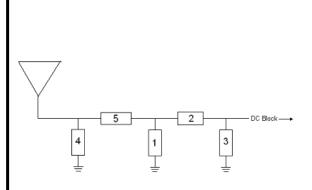
= 9





8-2. Matching circuit :

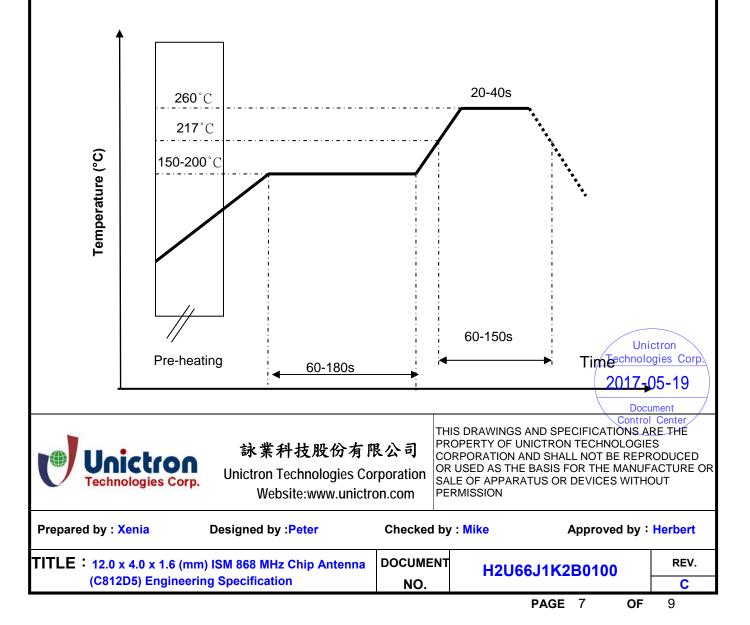
With the following recommended values of matching and tuning components, the center frequencies will be about 868 MHz at our standard 80 x 40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.



System Matching Circuit Component							
Location	Description	Vendor	Tolerance				
1	1.8pF, (0402)	MURATA-	±0.05pF				
2	0Ω	-	-				
3	N/A	-	-				
4							
Fine tuning	N/A	-	-				
element							
5							
Fine tuning	8.2nH, (0402)	MURATA-	±5%				
element							

9. Soldering Conditions

Typical Soldering Profile for Lead-free Process

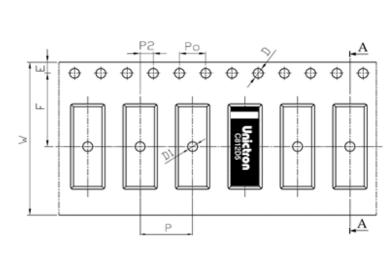


10. Packing

- (1) Quantity/Reel: 3500 pcs/Reel
- (2) Plastic tape: Black Conductive Polystyrene.

a. Tape Drawing

b. Tape Dimensions (unit: mm)



Feature	Specification	Tolerance	
	S	S	
W	24.00	±0.30	
Р	8.00	±0.10	
E	1.75	±0.10	
F	11.50	±0.10	
P2	2.00	±0.10	
D	1.50	+0.10	
U	1.50	-0.00	
D1	1.50	±0.10	
Po	4.00	±0.10	
10Po	40.00	±0.20	

11. Operating & Storage Conditions

- 11-1. Operating
 - (1) Maximum Input Power: 2 W
 - (2) Operating Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
 - (3) Relative Humidity: 10% to 70%

11-2. Storage (sealed)

- (1) Storage Temperature: -5°C to 40°C
- (2) Relative Humidity: 20% to 70%
- (3) Shelf Life: 1 year

11-3. Storage (unsealed)

Meet the criteria of <u>J-STD-033 MSL2a</u>

11-4. Storage (After mounted on customer's PCB with SMT process)

- (1) Storage Temperature: -40 $^\circ\!\mathrm{C}$ to 85 $^\circ\!\mathrm{C}$
- (2) Relative Humidity: 10% to 70%



2017-05-19

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12. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

